## DEC 0 5 2005

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

They

Applicanting Suan J. Boon

Title:

METHOD OF PACKAGING AT A WAFER LEVEL

Docket No.:

303.601US3

Serial No.: 10/722,838

Filed:

November 26, 2003

Due Date: December 1, 2005

Examiner:

James M. Mitchell

Group Art Unit: 2813

## MS Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

- $\underline{X}$  Return postcard.
- X Response to Restriction Requirement (13 pgs.).
- X Supplemental Information Disclosure Statement (2 pgs.), Form 1449 (1 pg.) including authorization to charge Deposit Account No. 19-0743 in the amount of \$180.00 to cover the fee for consideration of Information Disclosure Statement under 97(c).

If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

Customer Number 21186

Atty: David R. Cochra

Reg. No. 46,632

Name

Signature

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

(GENERAL)